

RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

DESCRIPTION

The SSM9573 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness. The SOT-223 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

FEATURES

- Lower Gate Charge
- Simple Drive Requirement
- Fast Switching Characteristic

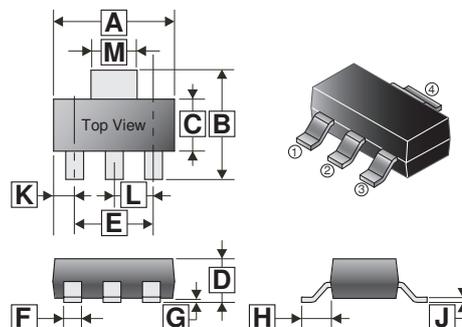
MARKING



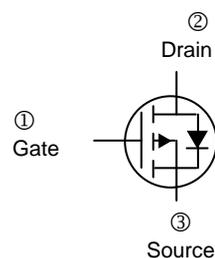
PACKAGE INFORMATION

Package	MPQ	Leader Size
SOT-223	2.5K	13 inch

SOT-223



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	5.90	6.70	G	-	0.18
B	6.70	7.30	H	2.00	REF.
C	3.30	3.80	J	0.20	0.40
D	1.42	1.90	K	1.10	REF.
E	4.45	4.75	L	2.30	REF.
F	0.60	0.85	M	2.80	3.20



ABSOLUTE MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V_{DS}	-60	V	
Gate-Source Voltage	V_{GS}	± 20	V	
Continuous Drain Current ¹ @ $V_{GS}=10\text{V}$	I_D	$T_A=25^{\circ}\text{C}$	-2.7	A
		$T_A=70^{\circ}\text{C}$	-2	A
Pulsed Drain Current ²	I_{DM}	-5	A	
Power Dissipation ³	P_D	1.5	W	
Operating Junction & Storage Temperature	T_J, T_{STG}	-55~150	$^{\circ}\text{C}$	
Thermal Resistance Rating				
Thermal Resistance Junction-Ambient ¹ (Max).	$R_{\theta JA}$	85	$^{\circ}\text{C} / \text{W}$	
Thermal Resistance Junction-Case ¹ (Max).	$R_{\theta JC}$	60	$^{\circ}\text{C} / \text{W}$	

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Static							
Drain-Source Breakdown Voltage	BV_{DSS}	-60	-	-	V	$V_{GS}=0, I_D = -250\mu\text{A}$	
Gate-Threshold Voltage	$V_{GS(th)}$	-1	-	-3	V	$V_{DS}=V_{GS}, I_D = -250\mu\text{A}$	
Gate-Source Leakage Current	I_{GSS}	-	-	± 100	nA	$V_{GS} = \pm 20\text{V}$	
Drain-Source Leakage Current	I_{DSS}	$T_J=25^\circ\text{C}$	-	-	-1	μA	$V_{DS} = -48\text{V}, V_{GS}=0$
		$T_J=55^\circ\text{C}$	-	-	-5		$V_{DS} = -48\text{V}, V_{GS}=0$
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	-	-	175	m Ω	$V_{GS} = -10\text{V}, I_D = -2.5\text{A}$	
		-	-	230		$V_{GS} = -4.5\text{V}, I_D = -1.5\text{A}$	
Total Gate Charge	Q_g	-	4.59	-	nC	$I_D = -2\text{A}$ $V_{DS} = -20\text{V}$ $V_{GS} = -4.5\text{V}$	
Gate-Source Charge	Q_{gs}	-	1.39	-			
Gate-Drain ("Miller") Charge	Q_{gd}	-	1.62	-			
Turn-on Delay Time ²	$T_{d(on)}$	-	17.4	-	nS	$V_{DS} = -15\text{V}$ $V_{GS} = -10\text{V}$ $R_G = 3.3\Omega$ $I_D = -1\text{A}$	
Rise Time	T_r	-	5.4	-			
Turn-off Delay Time	$T_{d(off)}$	-	37.2	-			
Fall Time	T_f	-	2.4	-			
Input Capacitance	C_{iss}	-	531	-	pF	$V_{GS} = 0$ $V_{DS} = 15\text{V}$ $f = 1.0\text{MHz}$	
Output Capacitance	C_{oss}	-	59	-			
Reverse Transfer Capacitance	C_{rss}	-	38	-			
Source-Drain Diode							
Diode Forward Voltage ²	V_{SD}	-	-	-1.2	V	$I_S = -1\text{A}, V_{GS} = 0$	
Continuous Source Current ^{1,4}	I_S	-	-	-2.7	A	$V_{DS} = V_{GS} = 0, \text{Force Current}$	
Pulsed Source Current ^{2,4}	I_{SM}	-	-	-5	A		

Note:

- Surface mounted on a 1 inch² FR4 board with 2OZ copper, $t \leq 10\text{sec.}$, $125^\circ\text{C}/\text{W}$ when mounted on Min. copper pad.
- The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- The power dissipation is limited by 150°C junction temperature
- The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

CHARACTERISTIC CURVES

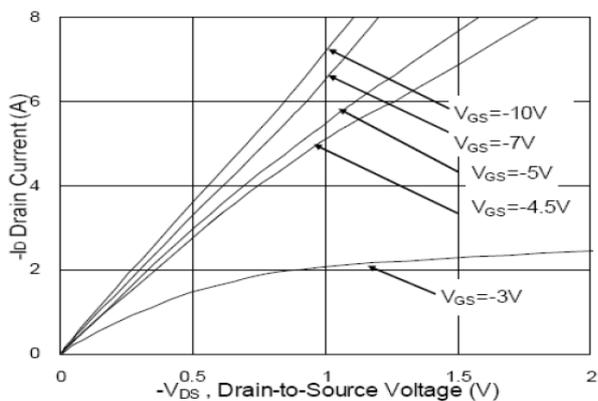


Fig.1 Typical Output Characteristics

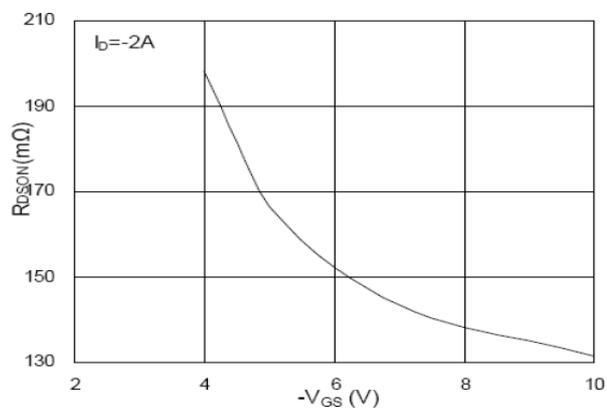


Fig.2 On-Resistance v.s Gate-Source

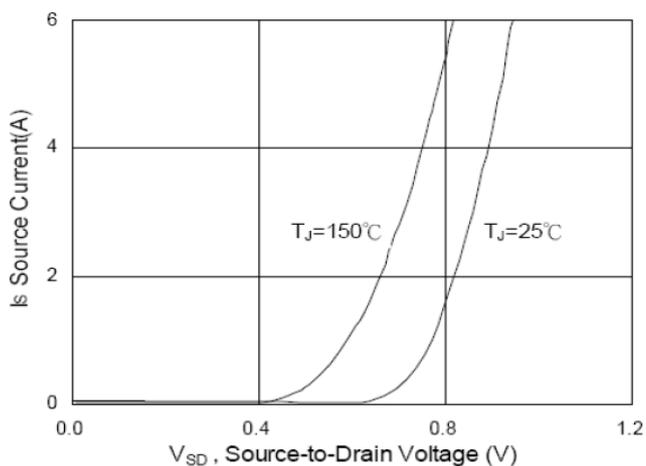


Fig.3 Forward Characteristics Of Reverse

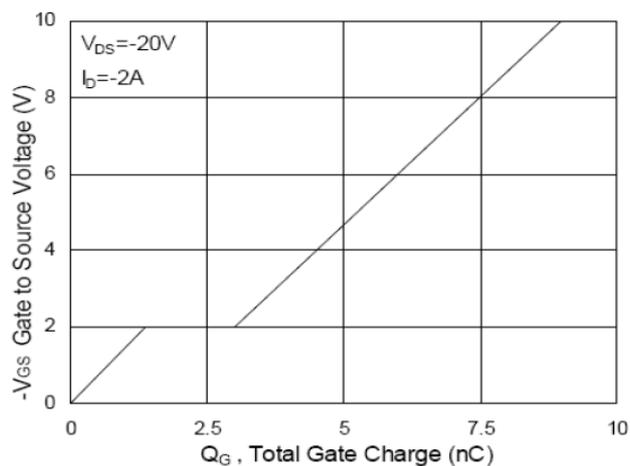


Fig.4 Gate-Charge Characteristics

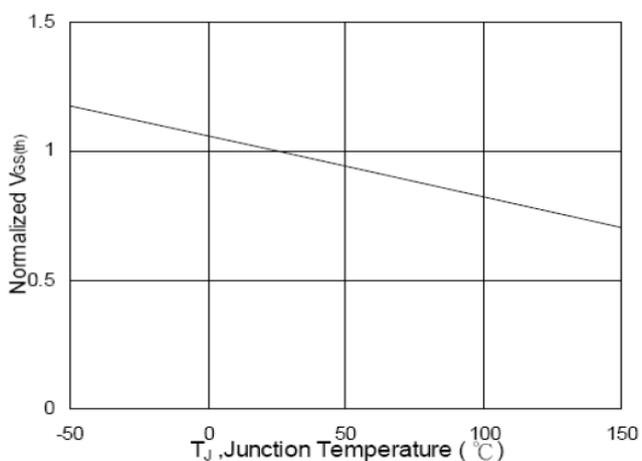


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

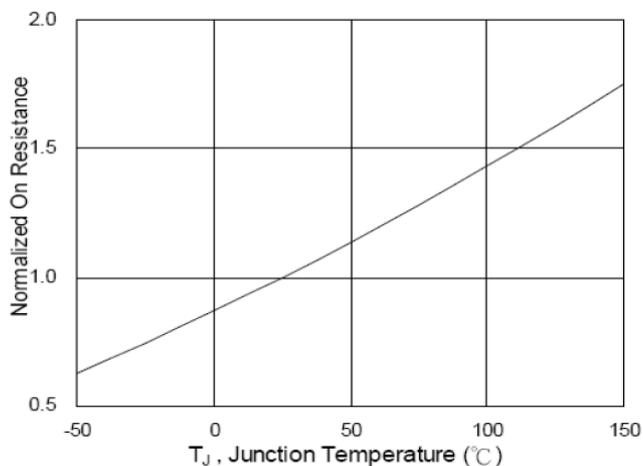


Fig.6 Normalized $R_{DS(ON)}$ v.s T_J

CHARACTERISTIC CURVES

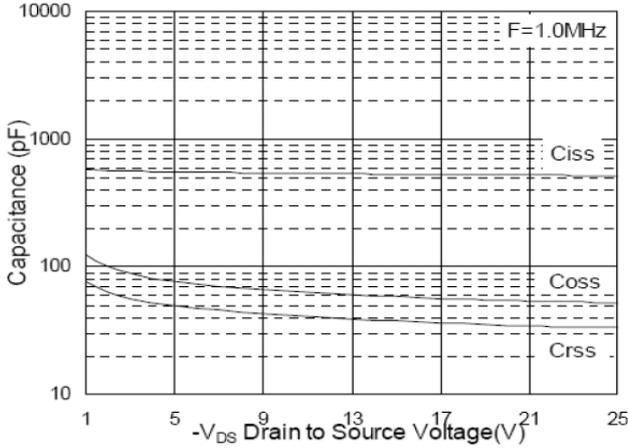


Fig.7 Capacitance

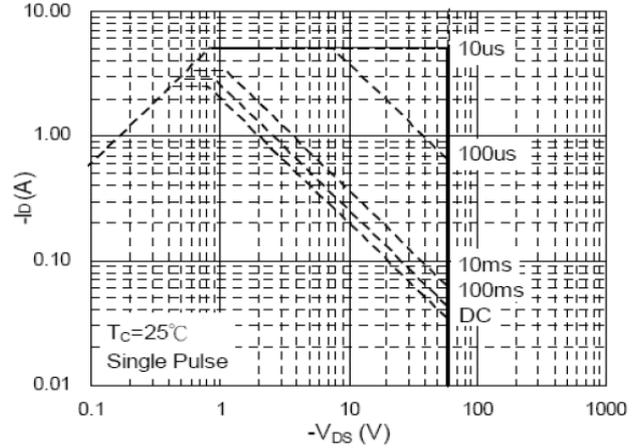


Fig.8 Safe Operating Area

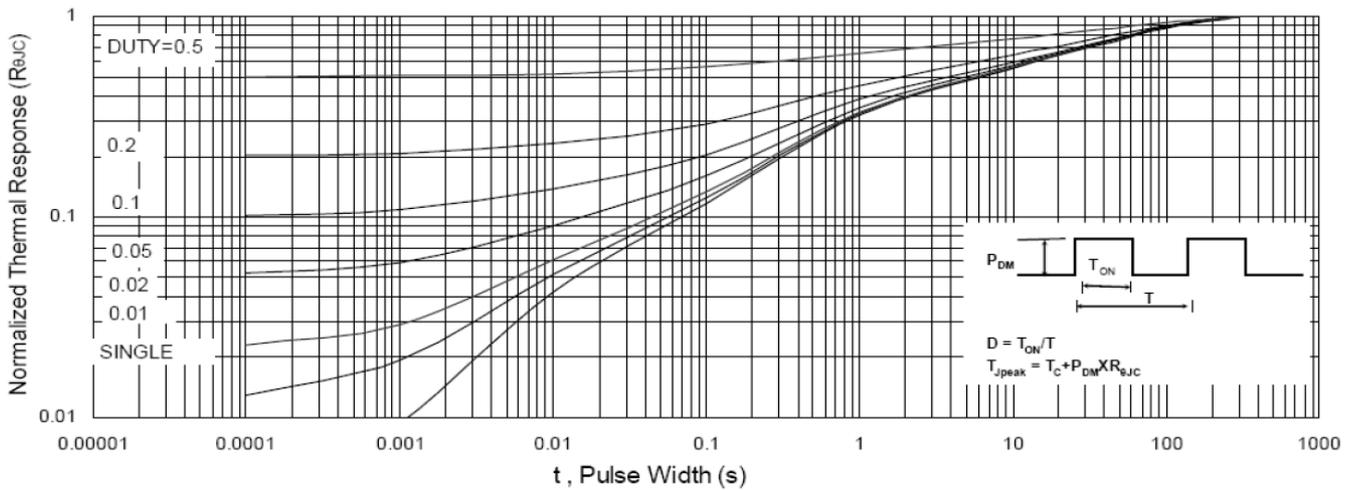


Fig.9 Normalized Maximum Transient Thermal Impedance

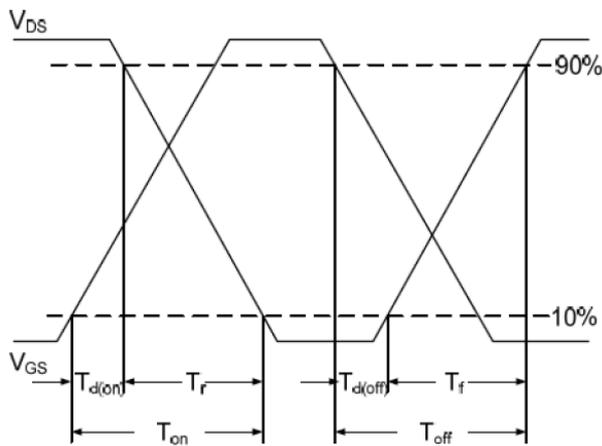


Fig.10 Switching Time Waveform

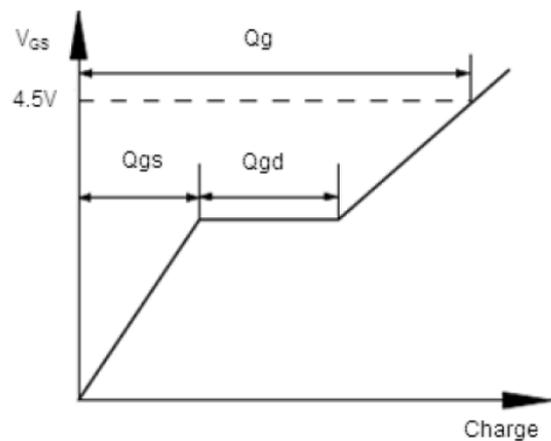


Fig.11 Gate Charge Waveform